

**cadence®**

## Cadence Design Systems

### ● 회사 소개

EDA(Electronic Design Automation) 분야의 세계 최대 마켓리더인 케이던스(Cadence Design Systems Inc.)는 전세계 반도체, 통신장비, 멀티미디어 및 가전제품 회사들이 모바일, 컨슈머, 클라우드, 데이터 센터, 자동차, 항공우주 산업, IoT 등 다양한 분야에서 다양한 제품을 적기에 개발, 생산 할 수 있도록 EDA 소프트웨어와 하드웨어, IP 및 디자인 서비스를 제공하고 있습니다. 세계 유수한 기업들은 물론 국내에서도 여러 주요 기업에서 전자설계를 위한 표준 툴로 사용하고 있습니다.

미국 캘리포니아주 산호세에 본사를 두고 세계 각지에 현지법인, 연구소, 디자인 센터를 두고 있으며, 포춘 100대 기업 리스트에 이름을 올렸습니다.

- Learn more at [www.cadence.com](http://www.cadence.com)



### ● 보유기술

1. EDA 전반 기술
2. AI/ML
3. System Analysis 기술

### ● 주력제품 및 서비스

1. Digital Design Tools: Genus - Modus - Tempus - Innovus
2. Analog Design Tools: Virtuoso - MMSIM/Spectre - Quantus - Pegasus - CMP/LPA
3. Verification Tools: Xcelium / P-Z1 / P-X1
4. Analysis Tools: PCB / Package(SIP) / Voltus / Sigrity / Clarity / Celsius / AWR / EMX

## Cadence Business Groups and Products

### Digital and Signoff

#### Front-End Design

- Stratus™** : High-level synthesis
- Genus™** : RTL synthesis
- Modus** : Test
- Joules™** : RTL power analysis
- Conforma®**: Formal equivalence

#### IC Digital

- Innovus™** : Implementation

#### Silicon Signoff and Verification

- Quantus™** : Extraction
- Liberate™** : Library characterization
- Tempus™** : Timing (STA)
- Pegasus™** : Physical signoff
- DFM / OPC** : Design for manufacture / optical proximity correction

### Custom IC and PCB

#### Custom IC

- Virtuoso®**: Custom/RF/mixed-signal and system design
- Spectre®** : Simulation
- Legato™** : Reliability analysis
- AXIEM®** : General RF/microwave EM analysis
- Microwave Office®** : Microwave RF design

#### IC, Package, and Board

- Allegro®** : IC package and PCB design
- OrbitIO™** : System-design planning
- OrCAD®** : Mainstream PCB design

#### Multi-Physics System Analysis

- Clarity™** : Electromagnetic analysis
- Celsius™** : Electro-thermal analysis
- Sigrity™** : System SI, PI, and thermal analysis
- Voltus™** : Power integrity analysis
- EMX®** : Specialized RFIC parasitic analysis

### System Verification

#### Hardware System Verification

- Palladium®** : Emulation
- Protium™** : FPGA prototyping
- SpeedBridge®** : Physical adapters
- VirtualBridge™**: Virtual adapters

#### Advanced Verification Solutions

- Xcelium™ ML** : Xcelium logic simulator with Machine learning
- Xcelium™** : IP and SoC simulation

#### Verification Fabric and Formal Solutions

- JasperGold®** : Formal verification
- System VIP** : System Verification IP
- VIP** : Interface Verification IP
- Perspec™** : Portable stimulus
- vManager™** : Verification management
- Indago™** : IP and SoC debug
- Functional Safety**

### Intellectual Property

#### Tensilica® IP

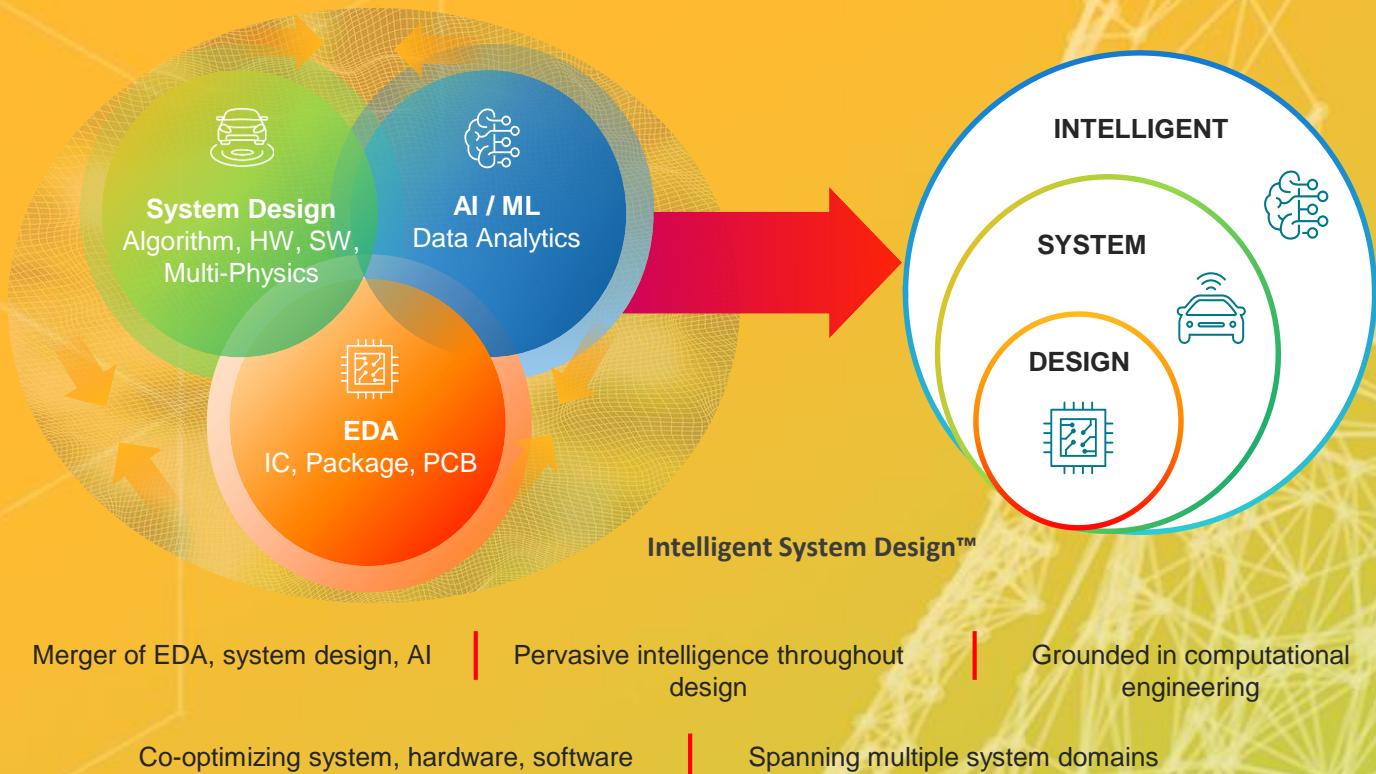
- DNA 100 DSPs** : Edge AI inferencing
- Vision DSPs** : Imaging, neural networks
- ConnX DSPs** : Baseband, communications
- HiFi DSPs** : Audio, voice, speech
- Fusion DSPs** : IoT and general purpose

#### Design IP

- Denali® Memory IP** : DRAM and flash interfaces
- Interface IP** : Serial interfaces
- Analog IP** : Analog/digital converters

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## Cadence Is Leading the Computational Software Convergence



## AI / Machine Learning Solutions

- Design excellence and enablement

### Key Benefits

Artificial intelligence (AI) promises to revolutionize people's lives. Whether it's autonomous cars or advances in the medical industry, we will all benefit from this revolution. Convolution and recurrent neural networks and machine and deep learning algorithms present the opportunity to enable this electronics revolution and create a new silicon renaissance with advances in software and IP.



#### Train Your Design

Machine learning inside our tools help designers learn from and improve their next-generation design.



#### Improve Productivity

Machine learning techniques built into our design flows provide better productivity for design teams.



#### Specialized IP

Optimized processor and advanced-memory IP enable product differentiation.

